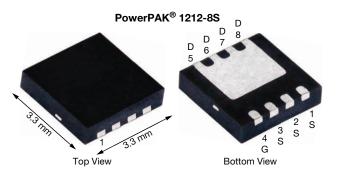
# SiSS70DN

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Vishay Siliconix

## N-Channel 125 V (D-S) MOSFET



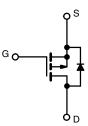
PRODUCT SUMMARY	
V <sub>DS</sub> (V)	125
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0298
Q <sub>g</sub> typ. (nC)	8
I <sub>D</sub> (A)	31 <sup>a</sup>
Configuration	Single

### **FEATURES**

- TrenchFET<sup>®</sup> with ThunderFET technology optimizes balance of R<sub>DS(on)</sub>, Q<sub>g</sub>, Q<sub>sw</sub>, and Q<sub>oss</sub>
- 100 %  $R_q$  and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### APPLICATIONS

- · Primary side switching
- Synchronous rectification
- DC/DC converter
- Motor drive control
- Load switch



RoHS

COMPLIANT HALOGEN

FREE

P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS70DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, un PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	125	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		31		
	T <sub>C</sub> = 70 °C		24.8		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	8.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	6.8 <sup>b, c</sup>	A	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	50		
	T <sub>C</sub> = 25 °C		54.8		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	4.2 <sup>b, c</sup>		
Single pulse avalanche current L = 0.1 mH		I <sub>AS</sub>	20		
Single pulse avalanche energy L = 0.1 mH		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		65.8		
Maximum power dissipation	T <sub>C</sub> = 70 °C		42.1	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5.1 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	3.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) <sup>c</sup>			260	°C	

#### THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.5	1.9	0/11	

#### Notes

a. T<sub>C</sub> = 25 °C

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 65 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	125	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 mA	-	92	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.1	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2.5	-	4.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA
7		V <sub>DS</sub> = 125 V, V <sub>GS</sub> = 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 125 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 10$ V, $V_{GS} = 10$ V	20	-	-	А
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8.5 A	-	0.0248	0.0298	Ω
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 8.5 A	-	16	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	535	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 62.5 V$ , $V_{GS} = 0 V$ , f = 1 MHz	-	157	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	$V_{DS} = 62.5 \text{ V}, V_{GS} = 0 \text{ V}, t = 1 \text{ MHz}$ - 157 - 8		-	1 '	
		$V_{DS} = 62.5 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8.5 \text{ A}$	-	10.2	15.3	
Total gate charge	Qg		-	8	12	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = 62.5 V, $V_{GS}$ = 7.5 V, $I_{D}$ = 8.5 A	-	3.2	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	2.7	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 62.5 \text{ V}, V_{GS} = 0 \text{ V}$	-	26	39	
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.24	1.2	2.4	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	20	40	
Rise time	t <sub>r</sub>	$V_{DD} = 62.5 \text{ V}, \text{ R}_{\text{L}} = 9.2 \Omega, \text{ I}_{\text{D}} \cong 6.8 \text{ A},$	-	9	18	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	30	60	
Fall time	t <sub>f</sub>		-	10	20	
Turn-on delay time	t <sub>d(on)</sub>		-	22	44	ns
Rise time	tr	$V_{DD} = 62.5 \text{ V}, \text{ R}_1 = 9.2 \Omega, \text{ I}_D \cong 6.8 \text{ A},$	-	12	24	_
Turn-off delay time	t <sub>d(off)</sub>	$\begin{array}{c c c c c c c c c c c c c c c c c c c $		30	60	1
Fall time	t <sub>f</sub>		-	12	24	
Drain-Source Body Diode Characteristi	cs				1	
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	54.8	Ι.
Pulse diode forward current	I <sub>SM</sub>	-	-	-	50	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 6.8 A, V <sub>GS</sub> = 0 V	-	0.8	1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	46	92	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 6.8 A, di/dt = 100 A/μs,	-	82	164	nC
Reverse recovery fall time	t <sub>a</sub>	$I_F = 6.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ $T_J = 25 \text{ °C}$		37	-	
Reverse recovery rise time	t <sub>b</sub>		-	9	-	ns

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

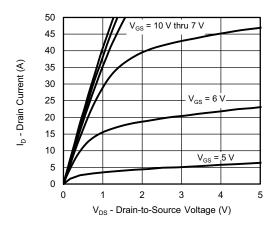
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

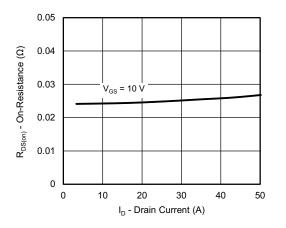
2



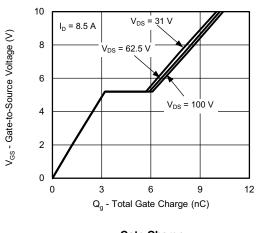
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



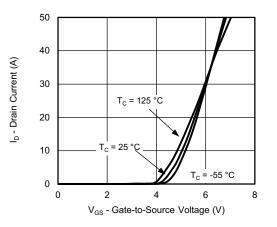
#### **Output Characteristics**



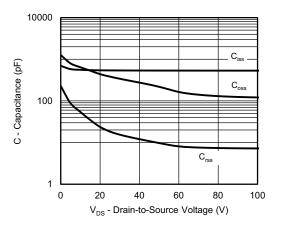
**On-Resistance vs. Drain Current and Gate Voltage** 



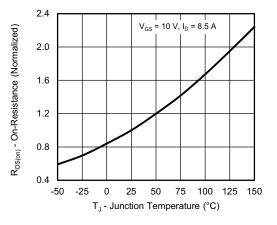
Gate Charge



#### **Transfer Characteristics**



Capacitance



**On-Resistance vs. Junction Temperature** 

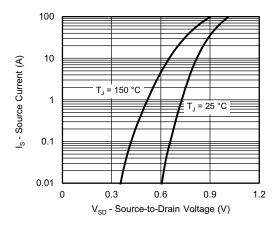
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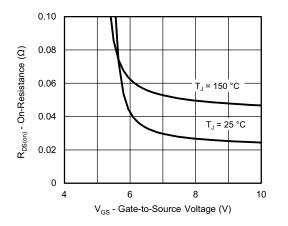
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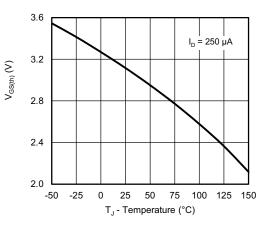
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



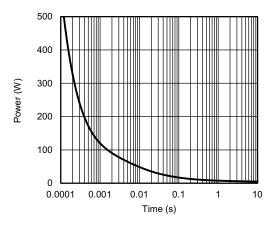
Source-Drain Diode Forward Voltage



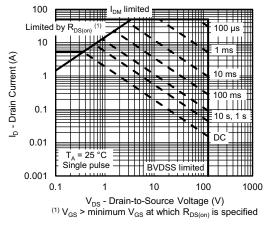
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



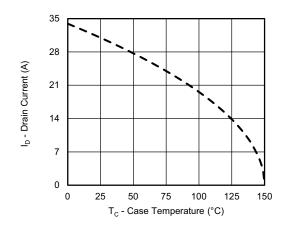
Safe Operating Area, Junction-to-Ambient

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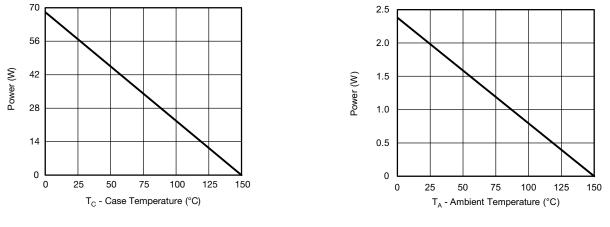
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating <sup>a</sup>



Power, Junction-to-Case

Power, Junction-to-Ambient

#### Note

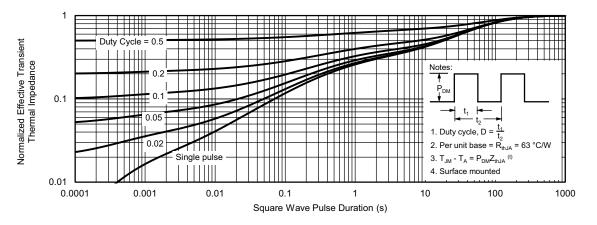
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



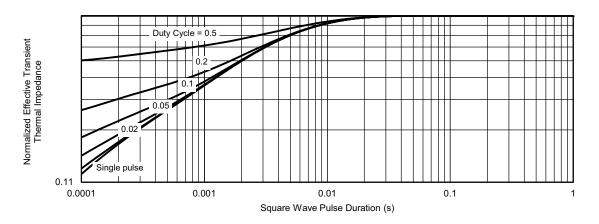
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?76612">www.vishay.com/ppg?76612</a>.



# Case Outline for PowerPAK<sup>®</sup> 1212-8S







DIM		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	MIN. NOM.			
А	0.67	0.75	0.83	0.026	0.030	0.033		
A1	0.00	-	0.05	0.000	-	0.002		
A3		0.20 ref.			0.008 ref	•		
b	0.25	0.30	0.35	0.010	0.012	0.014		
D	3.20	3.30	3.40	0.126	0.130	0.134		
D1	2.15	2.25	2.35	0.085	0.089	0.093		
E	3.20	3.30	3.40	0.126	0.130	0.134		
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е		0.65 bsc.			0.026 bsc.			
К		0.76 ref.			0.030 ref.			
K1		0.41 ref.		0.016 ref.				
L	0.33	0.43	0.53	0.013	0.017	0.021		
Z	0.525 ref.			0.021 ref.				
N: C20-0862-Re /G: 6008	v. B, 20-Jul-2020			•				



## RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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